

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHANG-HYEON JI	06/27/2017
JONG UK BU	06/28/2017
RECEIVING PARTY DATA	
Name:	SENPLUS INC.
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Postal Code:	16229
Name:	EWHA UNIVERSITY - INDUSTRY COLLABORATION FOUNDATION
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15647554
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ATTORNEY DOCKET NUMBER:	MHN17302
NAME OF SUBMITTER:	ELLEN MCKEAN
SIGNATURE:	/Ellen McKean/

DATE SIGNED:	07/12/2017
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Total Attachments: 1 source=Assignment MHN17302 (as filed) 7-12-17#page1.tif
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ASSIGNMENT

WHEREAS, I/we, the following named inventor(s):

- 1. Chang-Hyeon Ji, residing in Seoul, Republic of Korea; and
- 2. Jong Uk BU, residing in Seongnam-si, Republic of Korea;

have invented an invention entitled **SCANNING MICROMIRROR**, for which I/we have executed an application for Letters Patent of the United States (check one):

- on the date I/we executed this assignment;
- as U.S. Patent Application No. 15/647,554, filed July 12, 2017;
- as International Application No. _____, filed _____;

I/we authorize the attorneys/agents authorized to act under Customer Number 145572 to insert the filing date and application number of said application when known.

WHEREAS, SenPlus Inc. and Ewha University - Industry Collaboration Foundation ("Assignees"), both Republic of Korea organizations, SenPlus Inc. having its principal place of business at 14F KANC, 109, Gwanggyo-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do 16229, Republic of Korea, and Ewha University - Industry Collaboration Foundation having its principal place of business at 52, Ewhayeodae-gil, Seodaemun-gu, Seoul 03760, Republic of Korea, desire that SenPlus Inc., acquire an 80% undivided interest therein and Ewha University - Industry Collaboration Foundation acquire a 20% undivided interest therein, collectively representing the entire interest therein;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I/we, the above named inventor(s), have sold, assigned, and transferred, and by these presents do sell, assign, and transfer unto Assignees, SenPlus Inc., a respective 80% interest in the full and exclusive right to the above-identified invention in the United States and its territorial possessions and in all foreign countries, and Ewha University - Industry Collaboration Foundation a respective 20% interest in the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries, and in and to any and all divisions, reissues, continuations and extensions thereof, and all priority rights under all present or future conventions and treaties, and any provisional applications for which priority is claimed.

I/We hereby authorize and request the Patent Office officials in the United States and any and all foreign countries to issue any and all of said Letters Patent, when granted, to Assignees, as the assignees of my/our entire right, title and interest in and to the same, for the sole use of the Assignees, their successors and assigns.

Further, I/we agree that I/we will communicate to Assignees, or their representatives, any facts known to me/us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to Assignees, make all rightful oaths and generally do everything possible to aid Assignees, their successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I/we have hereunto set my/our hand(s) on the dates indicated below.

- 1. Inventor Name: Chang-Hyeon Ji Signature: [Signature] Date: June 27, 2017
- 2. Inventor Name: Jong Uk BU Signature: [Signature] Date: June 28, 2017